TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX540F, TC74LCX540FT, TC74LCX540FK

Low-Voltage Octal Bus Buffer (inverted) with 5-V Tolerant Inputs and Outputs

The TC74LCX540 is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

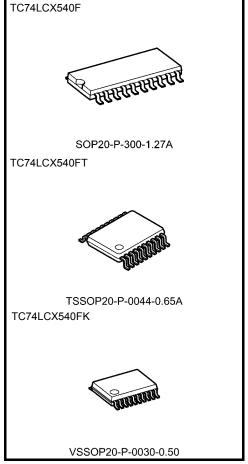
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

The TC74LCX540 is an inverting 3-state buffer having two active-low output enables. When either $\overline{OE}1$ or $\overline{OE}2$ are high, the terminal outputs are in the high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation: $t_{pd} = 6.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: >±500 mA
- Available in JEITA SOP, TSSOP and VSSOP (US)
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 540 type

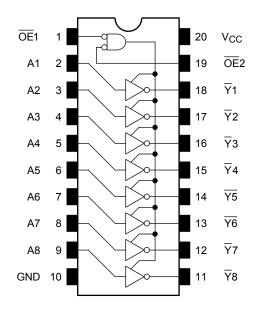


Weight:

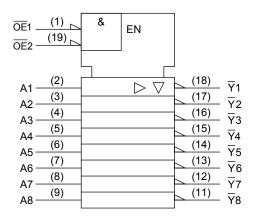
SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Note: The Electrical Characteristics of $V_{CC}=1.8\pm0.15V$ is only applicable for products which manufactured from January 2009 onward.

Pin Assignment (top view)



IEC Logic Symbol



Truth Table

	Inputs						
OE1	OE2	An	Outputs				
Н	Х	Х	Z				
Х	Н	Х	Z				
L	L	Н	L				
L	L	L	Н				

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	ΙΙΚ	-50	mA
Output diode current	I _{OK}	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	P _D	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Power supply voltage	1.65 to 3.6		V	
1 ower supply voltage	V _{CC}	1.5 to 3.6 (Note 2)	V	
Input voltage	V _{IN}	0 to 5.5	V	
Output voltage	V _{OUT}	0 to 5.5 (Note 3)	٧	
Output voltage		0 to V _{CC} (Note 4)		
Output current	I _{OH} /I _{OI}	±24 (Note 5)	mA	
Output current	iOH/iOL	±12 (Note 6)	ША	
Operating temperature	T _{opr}	–40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either V_{CC} or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$

Note 6: $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$

Note 7: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V



Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteris	tics	Symbol	Test Condition V _{CC} (V)		V _{CC} (V)	Min	Max	Unit	
H-level					1.65 to 2.3	V _{CC} × 0.9	_		
		V _{IH}	_	_		1.7	_		
Input voltage					2.7 to 3.6	2.0	_	V	
iliput voltage					1.65 to 2.3	_	V _{CC} × 0.1	V	
	L-level	V _{IL}	_		2.3 to 2.7	_	0.7		
					2.7 to 3.6	_	0.8		
				$I_{OH} = -100 \mu A$	1.65 to 3.6	V _{CC} -0.2			
				$I_{OH} = -4 \text{ mA}$	1.65	1.05			
	H-level	Vou	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -8 \text{ mA}$	2.3	1.7		- - - - - V	
	i i-level	V _{OH}	VIN = VIH OI VIL	$I_{OH} = -12 \text{ mA}$	2.7	2.2			
				$I_{OH} = -18 \text{ mA}$	3.0	2.4			
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2			
Output voltage			V VV	$I_{OL} = 100 \mu A$	1.65 to 3.6	_	0.2	V	
				$I_{OL} = 4 \text{ mA}$	1.65		0.45		
	L-level	Voi		$I_{OL} = 8 \text{ mA}$	2.3		0.7		
	L-level	VOL	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 12 \text{ mA}$	2.7	_	0.4	
				$I_{OL} = 16 \text{ mA}$	3.0		0.4		
				$I_{OL} = 24 \text{ mA}$	3.0	_	0.55		
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V	V _{IN} = 0 to 5.5 V		_	±5.0	μΑ	
3-state output off-state	off-state current I _{OZ}		$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = 0$ to 5.5 V		1.65 to 3.6	_	±5.0	μА	
Power off leakage cur	Power off leakage current		V _{IN} /V _{OUT} = 5.5 V		0	_	10.0	μА	
Quiescent supply curr	O de la contraction de la cont		V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0		
Quiescent supply cult		Icc	V _{IN} /V _{OUT} = 3.6 to 5	.5 V	1.65 to 3.6	_	±10.0	μΑ	
Increase in I _{CC} per in	ΔI_{CC} per input ΔI_{CC} $V_{IH} = V_{CC} - 0.6 \text{ V}$		2.7 to 3.6	_	500				



AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol	Symbol Test Condition		Min	Max	Unit
Characteristics	Symbol	rest Condition	V _{CC} (V)	IVIIII	IVIAX	Offic
			1.8±0.15	_	25.0	ns
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5±0.2	_	8.5	
Tropagation delay time	t _{pHL}	Tigure 1, Figure 2	2.7	_	7.5	113
			3.3 ± 0.3	1.5	6.5	
			1.8±0.15	_	34.0	ns
Output analyse times	t _{pZL} t _{pZH}	Figure 1, Figure 3	2.5±0.2	_	17.0	
Output enable time			2.7	_	9.5	
			3.3 ± 0.3	1.5	8.5	
			1.8±0.15	_	32.0	
Output disable time	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	2.5±0.2	_	16.0	ns
Output disable time			2.7	_	8.5	113
			3.3 ± 0.3	1.5	7.5	
Output to output skew	t _{osLH}	(Note)	2.7	_		ns
Output to output skew	t _{osHL}	(Note)	3.3 ± 0.3	_	1.0	113

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$

Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V_{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	_	3.3	7	pF
Output capacitance	C _{OUT}	_	3.3	8	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note) 3.3	40	pF

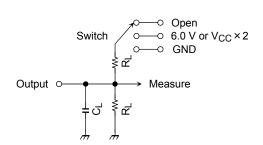
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$



AC Test Circuit



Parameter	Switch		
t _{pLH} , t _{pHL}	Open		
	6.0 V	@ V _{CC} =3.3±0.3V	
t t	@ V _{CC} =2.7V		
^t pLZ, ^t pZL	V _{CC} ×2	@ V _{CC} =2.5±0.2V	
		@ V _{CC} =1.8±0.15V	
t _{pHZ} , t _{pZH}	GND		

Figure 1

AC Waveform

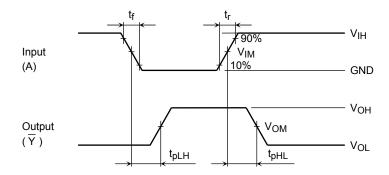


Figure 2 t_{pLH}, t_{pHL}

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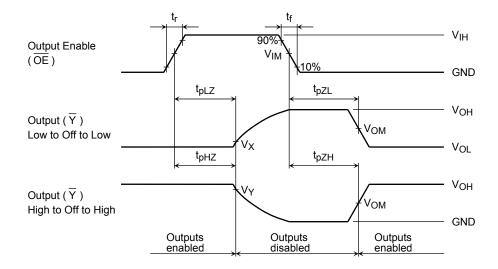


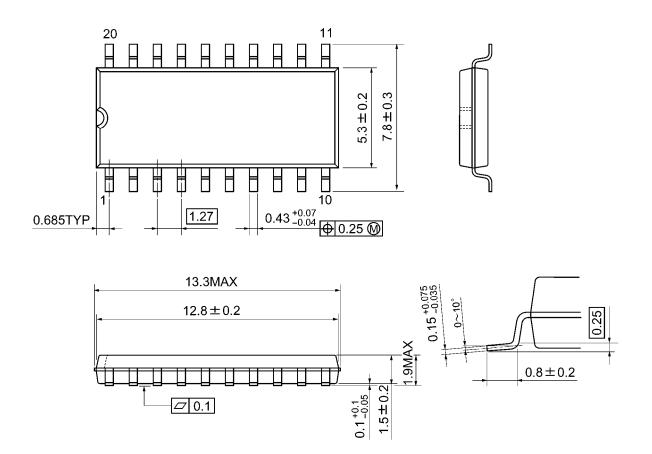
Figure 3 $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$

			V _{CC}	
	Symbol	3.3 ± 0.3 V 2.7V	2.5 ± 0.2 V	1.8 ± 0.15 V
Input	V _{IH}	2.7V	V _{CC}	V _{CC}
	V _{IM}	1.5V	V _{CC} /2	V _{CC} /2
	t _r , t _f	2.5ns	2.0ns	2.0ns
Output	V _{OM}	1.5V	V _{OH} /2	V _{OH} /2
	VX	V _{OL} +0.3V	V _{OL} +0.15V	V _{OL} +0.15V
	VY	V _{OH} -0.3V	V _{OH} -0.15V	V _{OH} -0.15V
Load	CL	50pF	30pF	30pF
	R_L	500Ω	500Ω	1kΩ



Package Dimensions

SOP20-P-300-1.27A Unit: mm

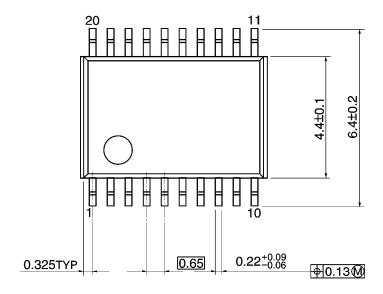


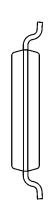
Weight: 0.22 g (typ.)

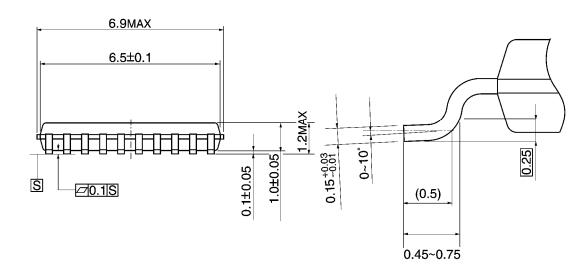
Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm



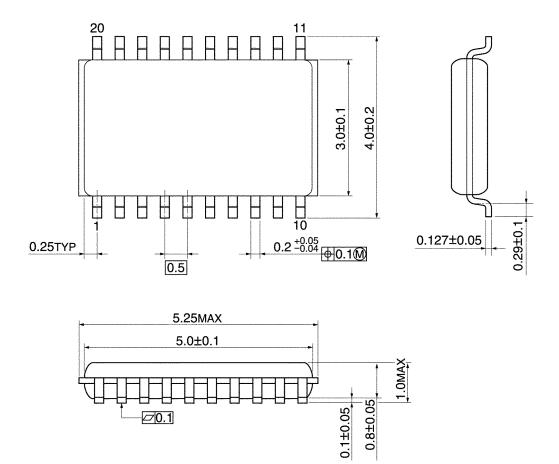




Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)

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